





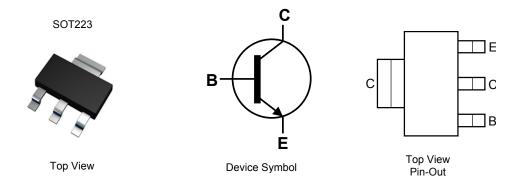
100V NPN HIGH PERFORMANCE TRANSISTOR IN SOT223

Features

- BV_{CEO} > 100V
- I_C = 3A High Continuous Current
- I_{CM} = 6A Peak Pulse Current
- Low Saturation Voltage V_{CE(sat)} < 300mV @ 1A
- Complementary PNP Type: FZT753
- Lead-Free Finish; RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Mechanical Data

- Case: SOT223
- Case material: molded plastic. "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (approximate)



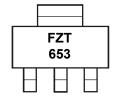
Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT653TA	AEC-Q101	FZT653	7	12	1,000
FZT653QTA	Automotive	FZT653	7	12	1,000
FZT653TC	AEC-Q101	FZT653	13	12	4,000

Notes:

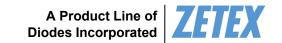
- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



FZT653 = Product Type Marking Code





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	120	V
Collector-Emitter Voltage	V _{CEO}	100	V
Emitter-Base Voltage	V_{EBO}	7	V
Continuous Collector Current	Ic	2	Α
Peak Pulse Current	I _{CM}	6	Α

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 6)	В	2	W
Power Dissipation	(Note 7)	P _D	3	W
Thermal Resistance, Junction to Ambient	(Note 6)	Б	62.5	°C/W
Thermal Resistance, Junction to Ambient	(Note 7)	R _{0JA}	41.7	°C/W
Thermal Resistance, Junction to Leads (Note 8)		R _{0JL}	12.9	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

^{6.} For a device mounted with the collector lead on 25mm x 25mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.

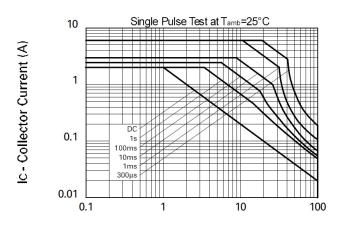
^{7.} Same as note (6), except the device is mounted on 50mm x 50mm 2oz copper.

8. Thermal resistance from junction to solder-point (at the end of the collector lead).

9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

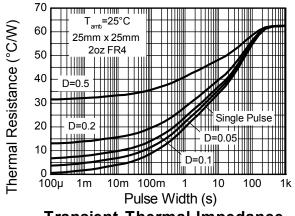


Thermal Characteristics and Derating Information

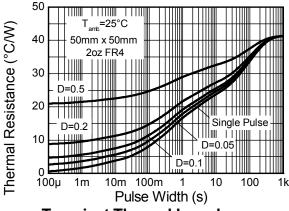


VCE - Collector Emitter Voltage (V)

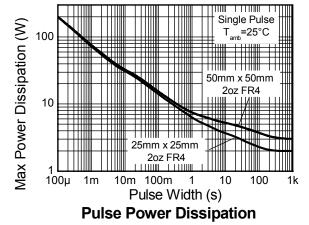
Safe Operating Area

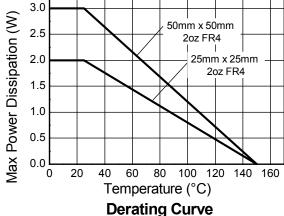


Transient Thermal Impedance



Transient Thermal Impedance









Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	120	-	_	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Note 10)	BV _{CEO}	100	_	_	V	I _C = 1mA
Emitter-Base Breakdown Voltage	BV_{EBO}	7	-	_	V	I _E = 100μA
Collector Cut-off Current		-	< 1	100	nA	V _{CB} = 100V
Collector Cut-on Current	I _{CBO}	_	-	10	μΑ	V _{CB} = 100V, T _A = +125°C
Emitter Cut-off Current	I _{EBO}	-	< 1	100	nA	V _{EB} = 5.6V
Collector-Emitter Saturation Voltage (Note 10)	V	-	0.13	0.3	V	I _C = 1A, I _B = 100mA
Collector-Emitter Saturation voltage (Note 10)	V _{CE(sat)}	-	0.23	0.5	V	I _C = 2A, I _B = 200mA
Base-Emitter Saturation Voltage (Note 10)	V _{BE(sat)}	_	0.9	1.25	V	I _C = 1A, I _B = 100mA
Base-Emitter Turn-On Voltage (Note 10)	$V_{BE(on)}$	-	0.8	1.0	V	I _C = 1A, V _{CE} = 2V
		70	200	_		I _C = 50mA, V _{CE} = 2V
DC Current Gain (Note 10)	h _{FE}	100	200	300		I _C = 500mA, V _{CE} = 2V
DC Current Gain (Note 10)		55	110	_	_	I _C = 1A, V _{CE} = 2V
		25	55	_		$I_C = 2A, V_{CE} = 2V$
Current Gain-Bandwidth Product (Note 10)	f _T	140	175	-	MHz	$V_{CE} = 5V, I_{C} = 100mA,$ f = 100MHz
Switching Times	t _{on}	-	80	_	20	I _C = 500mA, V _{CC} = 10V,
Switching Times	t _{off}	-	1200	-	ns	$I_{B1} = -I_{B2} = 50 \text{mA}$
Output Capacitance (Note 10)	C_{obo}	-	_	30	pF	V _{CB} = 10V, f = 1MHz

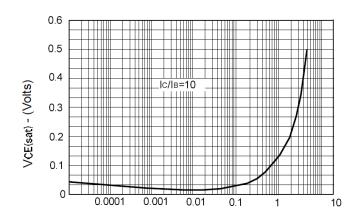
Note: 10. Measured under pulsed conditions. Pulse width $\leq 300 \mu s$. Duty cycle $\leq 2\%$



VBE(sat) - (Volts)

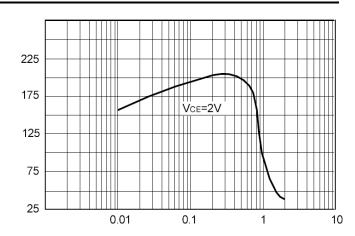
FZT653

Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)





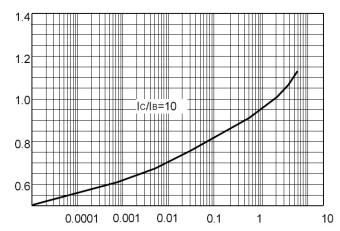
VBE - (Volts)



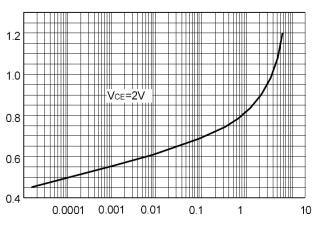
Ic - Collector Current (Amps)

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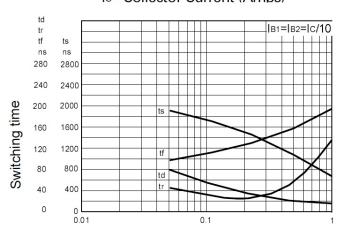




hfe v IC



Ic - Collector Current (Amps)



Ic - Collector Current (Amps)

VBE(on) v IC

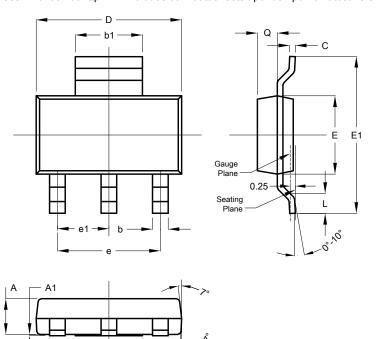
Ic - Collector Current (Amps)

Switching Speeds



Package Outline Dimensions

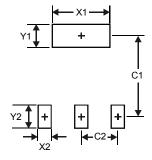
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b1	2.90	3.10	3.00		
b2	0.60	0.80	0.70		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	_	_	4.60		
e1	_	_	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X1	3.3
X2	1.2
Y1	1.6
Y2	1.6
C1	6.4
C2	2.3

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.





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